

## FDH / FDLL 600



DO-35



LL-34

THE PLACEMENT OF THE EXPANSION GAP  
HAS NO RELATIONSHIP TO THE LOCATION  
OF THE CATHODE TERMINAL

**COLOR BAND MARKING**

| DEVICE  | 1ST BAND | 2ND BAND |
|---------|----------|----------|
| FDLL600 | RED      | WHITE    |

### High Conductance Ultra Fast Diode

Sourced from Process 1R. See MMBD1201-1205 for characteristics.

#### Absolute Maximum Ratings\*

TA = 25°C unless otherwise noted

| Symbol         | Parameter                                                                               | Value       | Units  |
|----------------|-----------------------------------------------------------------------------------------|-------------|--------|
| $W_{IV}$       | Working Inverse Voltage                                                                 | 50          | V      |
| $I_O$          | Average Rectified Current                                                               | 200         | mA     |
| $I_F$          | DC Forward Current                                                                      | 400         | mA     |
| $I_{fr}$       | Recurrent Peak Forward Current                                                          | 600         | mA     |
| $I_{f(surge)}$ | Peak Forward Surge Current<br>Pulse width = 1.0 second<br>Pulse width = 1.0 microsecond | 1.0<br>4.0  | A<br>A |
| $T_{stg}$      | Storage Temperature Range                                                               | -65 to +200 | °C     |
| $T_J$          | Operating Junction Temperature                                                          | 175         | °C     |

\*These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

**NOTES:**

- 1) These ratings are based on a maximum junction temperature of 200 degrees C.
- 2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

#### Thermal Characteristics

TA = 25°C unless otherwise noted

| Symbol          | Characteristic                                | Max          | Units       |
|-----------------|-----------------------------------------------|--------------|-------------|
|                 |                                               | FDH/FDLL 600 |             |
| $P_D$           | Total Device Dissipation<br>Derate above 25°C | 500<br>3.33  | mW<br>mW/°C |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient       | 300          | °C/W        |

# High Conductance Ultra Fast Diode

(continued)

## Electrical Characteristics

TA = 25°C unless otherwise noted

| Symbol          | Parameter             | Test Conditions                                                                                                                                                                              | Min | Max                             | Units                     |
|-----------------|-----------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----|---------------------------------|---------------------------|
| B <sub>V</sub>  | Breakdown Voltage     | I <sub>R</sub> = 5.0 μA                                                                                                                                                                      | 75  |                                 | V                         |
| I <sub>R</sub>  | Reverse Current       | V <sub>R</sub> = 50 V<br>V <sub>R</sub> = 50 V, T <sub>A</sub> = 150°C                                                                                                                       |     | 100<br>100                      | nA<br>μA                  |
| V <sub>F</sub>  | Forward Voltage       | I <sub>F</sub> = 1.0 mA<br>I <sub>F</sub> = 10 mA<br>I <sub>F</sub> = 50 mA<br>I <sub>F</sub> = 100 mA<br>I <sub>F</sub> = 200 mA                                                            |     | 650<br>790<br>860<br>920<br>1.0 | mV<br>mV<br>mV<br>mV<br>V |
| C <sub>O</sub>  | Diode Capacitance     | V <sub>R</sub> = 0, f = 1.0 MHz                                                                                                                                                              |     | 2.5                             | pF                        |
| T <sub>RR</sub> | Reverse Recovery Time | I <sub>F</sub> = I <sub>R</sub> = 10 mA, I <sub>rr</sub> = 1.0 mA,<br>R <sub>L</sub> = 100 Ω<br>I <sub>F</sub> = I <sub>R</sub> = 200 mA, I <sub>rr</sub> = 20 mA,<br>R <sub>L</sub> = 100 Ω |     | 4.0<br>6.0                      | nS<br>nS                  |

FDH600 / FDLL600

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